



SF2510LM

MAXIMUM RATING:

• Maximum Input Power Level: 15 dBm (In passband)

• DC Voltage: +/-5 V

• Operating Temperature: -30 °C to +85 °C

• Storage Temperature Range: -40 °C to +100 °C

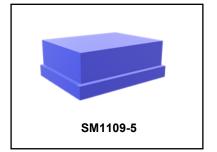
• Moisture Sensitivity Level: Level 1 (MSL 1)

• ESD: 50 V(MM), 100 V(HBM)

ELECTRICAL CHARACTERISTICS:

Terminating source impedance: Zs = 50 Ω (Single-ended) Terminating load impedance: ZL = 50 Ω (Single-ended)

1582.47 MHz SAW Filter



Paramete	rs Description	Unit	Min.	Тур.	Max.
Center Frequency	Fc	MHz	-	1582.47	-
	1574.42 ~ 1576.42 MHz	dB(*1)	-	1.2	1.7
Insertion Loss	1597.55 ~ 1605.89 MHz	dB(*1)	-	1.8	2.5
	1559.05 ~ 1563.14 MHz	dB(*1)	-	1.7	2.5
	1574.42 ~ 1576.42 MHz	dB	-	0.1	8.0
Amplitude Ripple	1597.55 ~ 1605.89 MHz	dB	-	0.55	1.4
	1559.05 ~ 1563.14 MHz	dB	-	0.2	1.2
	1574.42 ~ 1576.42 MHz	ns	-	1.0	6.0
Group Delay Ripple	1597.55 ~ 1605.89 MHz	ns	-	4.0	12.5
	1559.05 ~ 1563.14 MHz	ns	-	5.0	16.0
	1574.42 ~ 1576.42 MHz	-	-	1.5	2.1
VSWR	1597.55 ~ 1605.89 MHz	-	-	1.4	2.0
	1559.05 ~ 1563.14 MHz	-	-	1.5	2.0
Attenuation (Reference	ce level from 0 dB)				

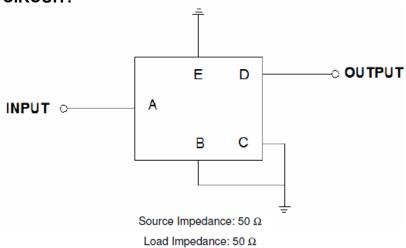
CAUTION: Electrostatic Sensitive Device. Observe precautions for handling. NOTES:

- 1. The design, manufacturing process, and specifications of this device are subject to change.
- 2. US or International patents may apply.
- 3. RoHS compliant from the first date of manufacture.

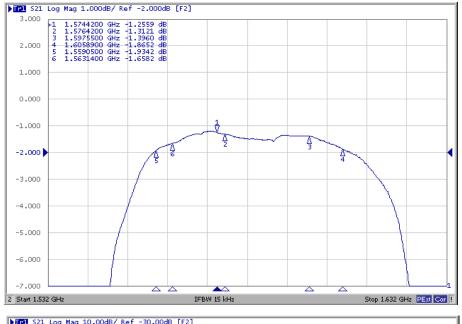
699 ~ 716 MHz	dB	43	47	1
777 ~ 787 MHz	dB	45	46.5	-
814 ~ 849 MHz	dB	45	46.5	-
880 ~ 915 MHz	dB	45	46.5	1
1427.9 ~ 1446.9 MHz	dB	45	53	-
1447.9 ~ 1462.9 MHz	dB	45	54	-
1710 ~ 1785 MHz	dB	47	54	1
1850 ~ 1915 MHz	dB	47	54	-
1920 ~ 1980 MHz	dB	47	54	-
2400 ~ 2500 MHz	dB	45	50	1
2500 ~ 2570 MHz	dB	45	50	-
(44) 0 15 11 51 11 1 1 1 1 1 1 1				

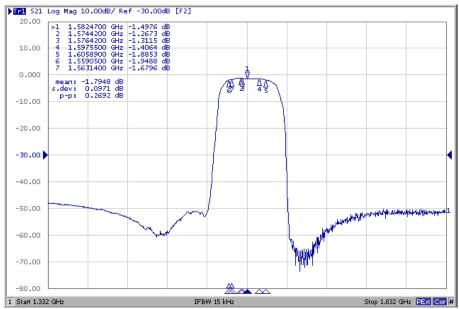
^(*1) Specification of insertion loss excludes loss that comes from the test board.

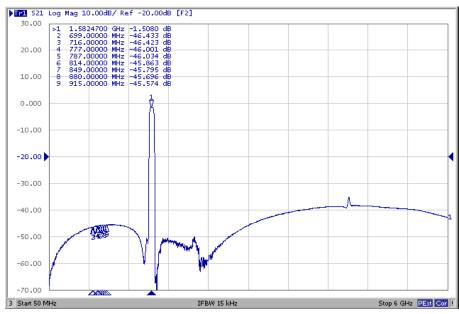
MEASUREMENT CIRCUIT:



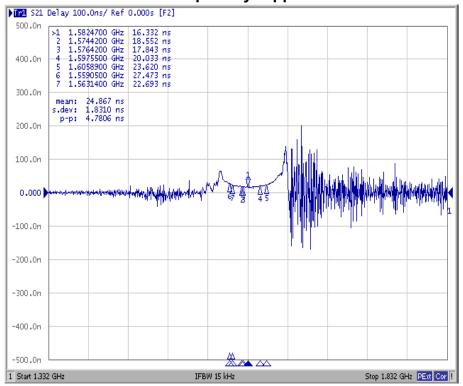
FREQUENCY CHARACTERISTICS:





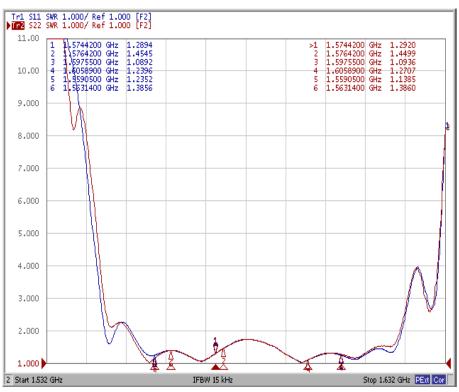


Group Delay Ripple

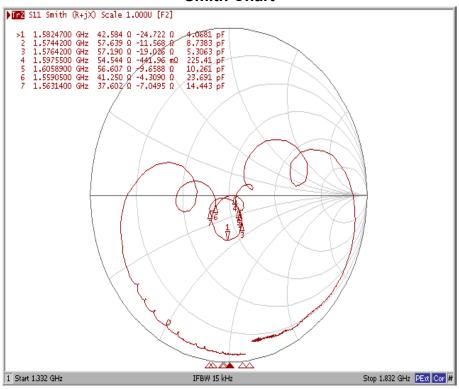


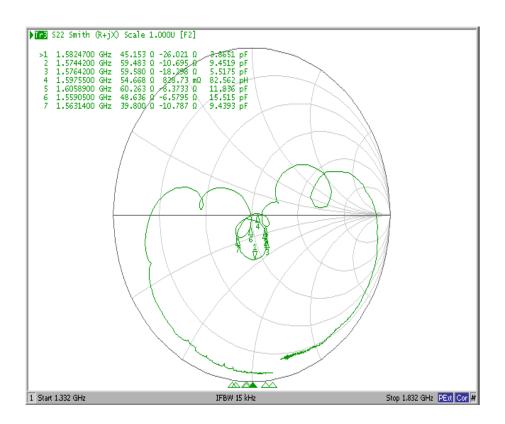
Reflection Functions:

VSWR

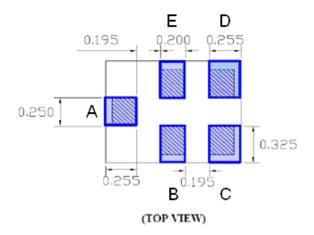


Smith Chart



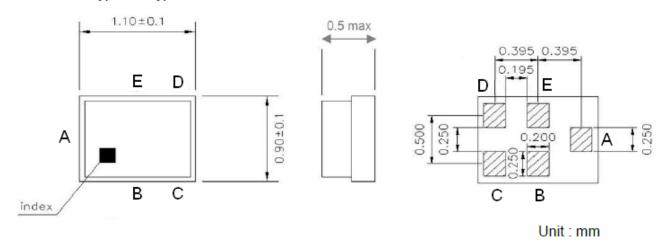


PCB Footprint:



OUTLINE DRAWING:

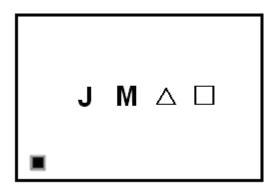
Device size: 1.1typ. x 0.9typ. x 0.5max.



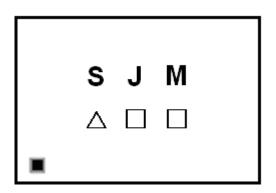
Pin Configuration

Pin No.	Symbol	Function		
Α	IN	Unbalanced input		
В	GND	Ground		
С	GND	Ground		
D	OUT	Unbalanced output		
E	GND	Ground		

Top View (Sample Production):



Top View (Mass Production):



 \triangle : Date Code

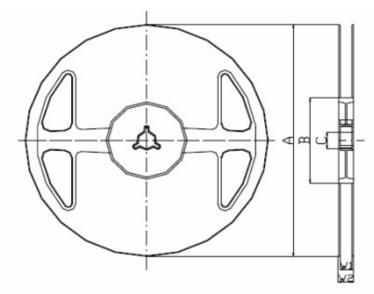
☐ : Lot No. (Indicated by 0~9 or A to Z and a to z, except I, O, i, o and I)

Date Code:

Year	Jan.	Feb.	Mar.	Apr.	May	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.
2020	n	р	р	r	s	t	a	>	8	x	у	Z
2021	Α	В	С	Ð	Е	F	G	Н	J	K	L	Μ
2022	Ν	Р	Q	R	S	Т	U	∇	W	Х	Υ	Z
2023	a	b	С	d	е	f	g	h	j	k	I	m

PACKING:

REEL DIMENSION



Materials of Reel

Material: Polvstvrene + Carbon

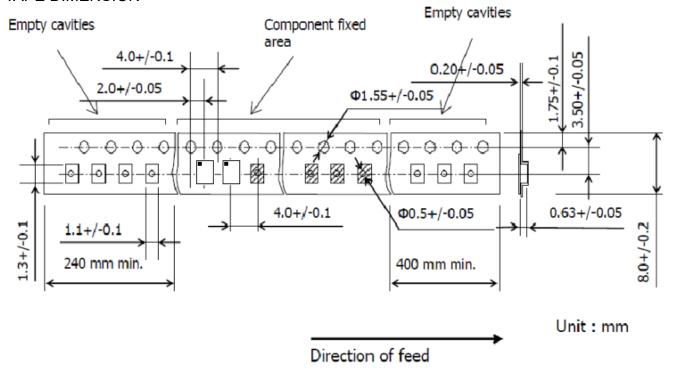
Color: Black

Surface resistance (reference value) : $10^9\Omega$ /sq Max.

Unit: mm

Code	Quantity	Α	В	С	W1	W2
J	5,000 pcs	φ 180.0 +0.0/-1.5	φ 66.0 +/-0.5	φ 13.0 +/-0.2	9.0 +1.0/-0.0	11.4 +/-1.0

TAPE DIMENSION



Recommended Reflow Profile

- 1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
- 2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
- 3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C +0/-5°C peak (10 seconds).
- 4. Time: 5 times maximum.

